



TG-T1000 Thermal Tape

REACH Compliant RoHS Compliant

Features

- · Good adhesion
- Great reliability
- · Cost effective with great performance
- · Easy to assemble
- · Customization services

Application:

Electronic Components - 5G, Aerospace, AI, AIoT, AR/VR/MR/XR, Automotive, Consumer Devices, Datacom, Electric Vehicle, Electronic Products, Energy Storage, Industrial, Lighting Equipment, Medical, Military, Netcom, Panel, Power Electronics, Robot, Servers, Smart Home, Telecom, etc.

Storage:

T-Global guarantees a 6-month shelf life at maximum continuous storage. Storage temperature should be under 25°C to maintain controlled adhesion to the liner.

Properties

Thermal Conductivity: 1 W/m•K

0 0.8 1.2 1.4 1.6 1.7 1.8 2.2 3.2 3.6 4.0 4.5 5.0 20

Properties	Unit	TG-T1000		Tolerance	Test Method
Thermal Conductivity	W/m•K	1	1	±10%	ASTM D5470 Modified
Thickness	mm	0.15	0.25	-	ASTM D374
Color	-	White		-	-
Reinforcement Carrier	-	Fiberglass mesh		-	-
Operating Temperature	°C	-30~+120		-	-
Short time use temperature (30sec)	°C	180		-	-
Density	g/cm³	1.2		-	ASTM D792
Initial Tack	cm	19	11	-	PSTC-6
Holding Power 1000g@25° Cusing 1 in ²	min	>3000		-	PSTC-7
180° Peeling Strength (Aluminum)	N / 25mm	>14	>16	-	PSTC-101
Dielectric Breakdown Voltage (AC)	KV	≥3	≥6	-	ASTM D149
Thermal Impedance@10psi	° C*in² / W	0.93	1.26		ASTM D5470 Modified
Thermal Impedance@30psi	° C*in² / W	0.76	1.06	-	ASTM D5470 Modified
Thermal Impedance@50psi	° C*in² / W	0.61	1.05	-	ASTM D5470 Modified

^{*}Die-cut for different shapes

%Roll type available

T-Global USA LLC

2880 Zanker Road, Suite 103, San Jose, CA 95134, USA T +1(669)345-0002 E usa@tglobal-usa.com

manufacture or to use any product in conflict with existing or future patents covering any product or material or its use.

W www.tglobal-usa.com







